

PATENT

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Denise Sheridan

Date

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 09/974,958

Confirmation No. : 7582

Applicants: Vernon M. Williams and Michael D. Gifford

: October 10, 2001

Attorney Docket No.: 501062.01

Art Unit : 1722 Customer No.

: 27,076

Examiner: Robert B. Davis

Title

Filed

: LEADFRAME AND METHOD FOR REDUCING MOLD COMPOUND

ADHESION PROBLEMS

SUPPLEMENTAL RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office communication dated December 23, 2005, applicants further elect species B1. Claims 1-60 were previously elected for examination with the response filed September 29, 2005. Of these claims, the claims readable on elected species B1 are claims 1, 3, 4, 8, 12, 15, 17, 18, 20, 21, 22, 24, 25, 29, 33, 36, 38, 40, 41, 42, 44, 45, 49, 53, 56, 58 and 60.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 11 of this paper.